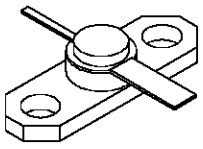
SGS-THOMSON MICROELECTRONICS

MSC82306

RF & MICROWAVE TRANSISTORS GENERAL PURPOSE AMPLIFIER APPLICATIONS

PRELIMINARY DATA

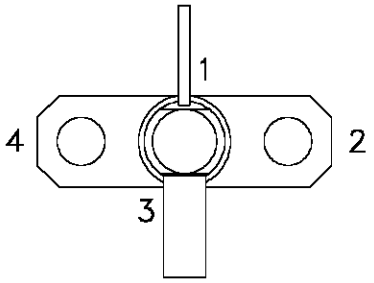
- REFRACTORY\GOLD METALLIZATION
- VSWR CAPABILITY 20:1 @ RATED CONDITIONS
- HERMETIC STRIPAC® PACKAGE
- P_{OUT} = 5.5 W MIN. WITH 9.6 dB GAIN



.250 2LFL (S010)
hermetically sealed

ORDER CODE	BRANDING
MSC82306	82306

PIN CONNECTION



1. Collector
2. Base
3. Emitter
4. Base

DESCRIPTION

The MSC82306 is a common base hermetically sealed silicon NPN microwave power transistor utilizing a rugged overaly die geometry. This device is capable of withstanding 20:1 load VSWR at any phase angle under rated conditions.

The MSC82306 was designed for Class C Amplifier/Oscillator applications in the 1.5 - 2.3 GHz frequency range.

ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C)

Symbol	Parameter	Value	Unit
P_{DISS}	Power Dissipation* ($T_C \leq 50°C$)	16.7	W
I_C	Device Current*	900	mA
V_{CC}	Collector-Supply Voltage*	26	V
T_J	Junction Temperature	200	°C
T_{STG}	Storage Temperature	– 65 to +200	°C

THERMAL DATA

$R_{TH(j-c)}$	Junction-Case Thermal Resistance*	9.0	°C/W

*Applies only to rated RF amplifier operation

ELECTRICAL SPECIFICATIONS (T_{case} = 25°C)

STATIC

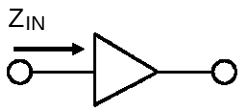
Symbol	Test Conditions		Value			Unit
			Min.	Typ.	Max.	
BV_{CBO}	I_C = 1mA	I_E = 0mA	44	—	—	V
BV_{EBO}	I_E = 1mA	I_C = 0mA	3.5	—	—	V
BV_{CER}	IC = 5mA	R_{BE} = 10Ω	44	—	—	V
I_{CBO}	V_{CB} = 22V		—	—	0.5	mA
h_{FE}	V_{CE} = 5V	I_C = 400mA	30	—	300	—

DYNAMIC

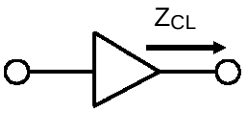
Symbol	Test Conditions			Value			Unit
				Min.	Typ.	Max.	
P_{OUT}	f = 2.3 GHz	P_{IN} = 0.6 W	V_{CC} = 22 V	5.5	6.3	—	W
ηc	f = 2.3 GHz	P_{IN} = 0.6 W	V_{CC} = 22 V	40	45	—	%
G_P	f = 2.3 GHz	P_{IN} = 0.6 W	V_{CC} = 22 V	9.6	10.2	—	dB
C_{OB}	f = 1 MHz	V_{CB} = 22 V		—	—	7.0	pF

IMPEDANCE DATA

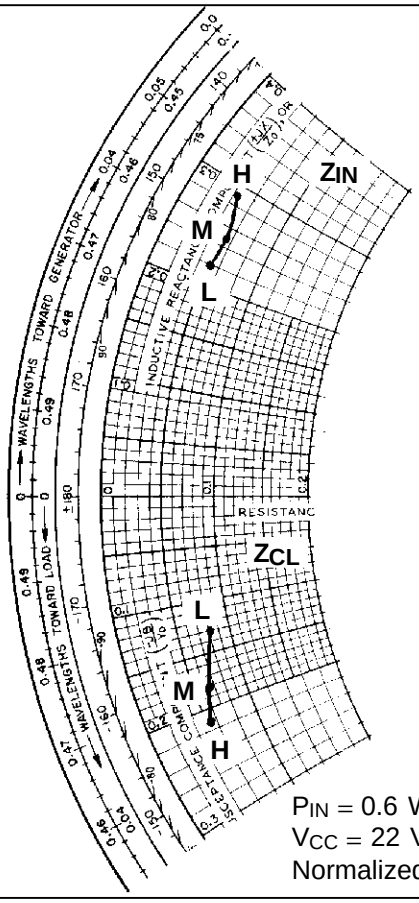
TYPICAL INPUT IMPEDANCE



TYPICAL COLLECTOR LOAD IMPEDANCE



FREQ.	Z_{IN} (Ω)	Z_{CL} (Ω)
L = 2.0 GHz	2.60 + j 11.0	4.1 – j 6.5
M = 2.15 GHz	2.75 + j 12.5	3.3 – j 9.0
H = 2.3 GHz	2.30 + j 14.5	2.8 – j 10.5

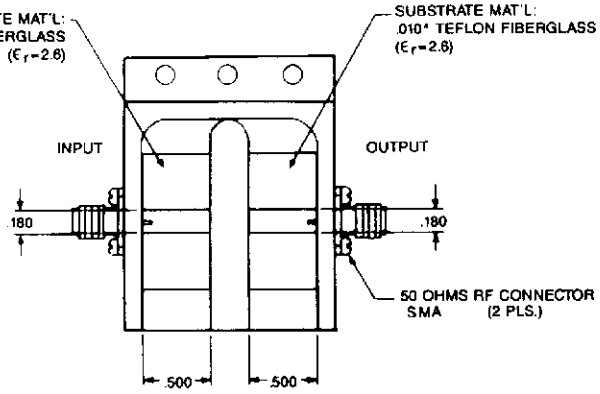


P_{IN} = 0.6 W
V_{CC} = 22 V
Normalized to 50 ohms

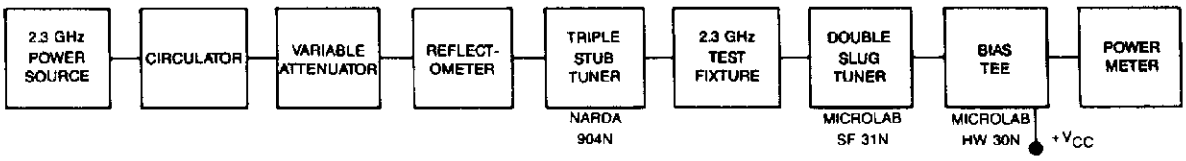
TEST CIRCUIT

Ref.: Dwg. No. C125518

All dimensions are in inches.
Frequency 2.3 GHz

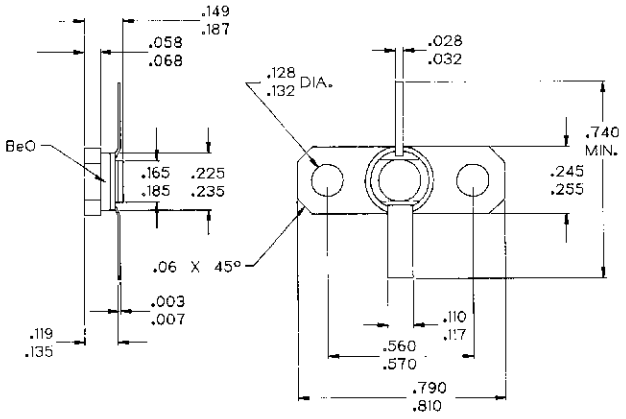


RF Amplifier Power Output Test



PACKAGE MECHANICAL DATA

Ref.: Dwg. No.: J135021C



NOTES:
1. ALL TOLERANCE ± .010 EXCEPT WHERE NOTED; DIMENSIONS IN INCHES.

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